

# 2SA2046

## Silicon PNP epitaxial planar type

For DC-DC converter

### ■ Features

- Low collector-emitter saturation voltage  $V_{CE(sat)}$
- Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing.

### ■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	$V_{CBO}$	-30	V
Collector-emitter voltage (Base open)	$V_{CEO}$	-20	V
Emitter-base voltage (Collector open)	$V_{EBO}$	-5	V
Collector current	$I_C$	-1.5	A
Peak collector current	$I_{CP}$	-5	A
Collector power dissipation *	$P_C$	400	mW
Junction temperature	$T_j$	150	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 to +150	$^\circ\text{C}$

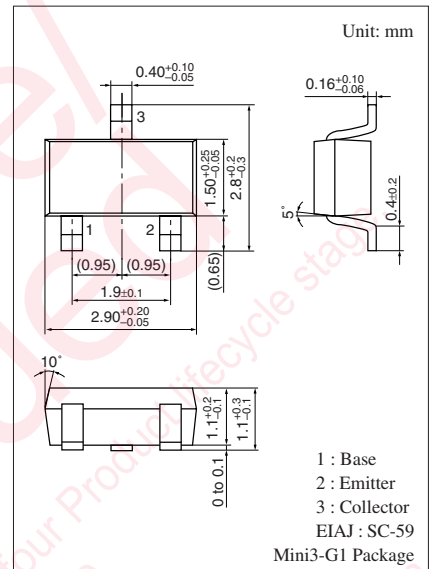
Note) \*: Measure on the ceramic substrate at 15 mm × 15 mm × 0.6 mm

### ■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-base voltage (Emitter open)	$V_{CBO}$	$I_C = -10 \mu\text{A}$ , $I_E = 0$	-30			V
Collector-emitter voltage (Base open)	$V_{CEO}$	$I_C = -1 \text{ mA}$ , $I_B = 0$	-20			V
Emitter-base voltage (Collector open)	$V_{EBO}$	$I_E = -10 \mu\text{A}$ , $I_C = 0$	-5			V
Forward current transfer ratio *	$h_{FE}$	$V_{CE} = -2 \text{ V}$ , $I_C = -100 \text{ mA}$	160		560	—
Collector-emitter saturation voltage *	$V_{CE(sat)}$	$I_C = -500 \text{ mA}$ , $I_B = -25 \text{ mA}$		-50	-150	mV
Transition frequency	$f_T$	$V_{CB} = -10 \text{ V}$ , $I_E = 20 \text{ mA}$ , $f = 200 \text{ MHz}$		170		MHz
Collector output capacitance (Common base, input open circuited)	$C_{ob}$	$V_{CB} = -10 \text{ V}$ , $I_E = 0$ , $f = 1 \text{ MHz}$		25	35	pF

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. \*: Pulse measurement



Marking Symbol: 3Z

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